

# 3.3-V 12-BIT UNIVERSAL BUS DRIVER WITH PARITY CHECKER AND DUAL 3-STATE OUTPUTS

SCES095C – MARCH 1997 – REVISED MAY 1998

- Member of the Texas Instruments *Widebus*™ Family
- *EPIC*™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Checks Parity
- Able to Cascade With a Second SN74ALVCH16903
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

## description

This 12-bit universal bus driver is designed for 2.3-V to 3.6-V  $V_{CC}$  operation.

The SN74ALVCH16903 has dual outputs and can operate as a buffer or an edge-triggered register. In both modes, parity is checked on APAR, which arrives one cycle after the data to which it applies. The YERR output, which is produced one cycle after APAR, is open drain.

MODE selects one of the two data paths. When MODE is low, the device operates as an edge-triggered register. On the positive transition of the clock (CLK) input and when the clock-enable ( $\overline{CLKEN}$ ) input is low, data set up at the A inputs is stored in the internal registers. On the positive transition of CLK and when  $\overline{CLKEN}$  is high, only data set up at the 9A–12A inputs is stored in their internal registers. When MODE is high, the device operates as a buffer and data at the A inputs passes directly to the outputs. 11A/YERR $\overline{EN}$  serves a dual purpose; it acts as a normal data bit and also enables YERR data to be clocked into the YERR output register.

When used as a single device, parity output enable ( $\overline{PAROE}$ ) must be tied high; when parity input/output (PARI/O) is low, even parity is selected and when PARI/O is high, odd parity is selected. When used in pairs and  $\overline{PAROE}$  is low, the parity sum is output on PARI/O for cascading to the second SN74ALVCH16903. When used in pairs and  $\overline{PAROE}$  is high, PARI/O accepts a partial parity sum from the first SN74ALVCH16903.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the 24 outputs and YERR in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)

$\overline{OE}$	1	56	CLK
1Y1	2	55	1A
1Y2	3	54	11A/YERR $\overline{EN}$
GND	4	53	GND
2Y1	5	52	11Y1
2Y2	6	51	11Y2
$V_{CC}$	7	50	$V_{CC}$
3Y1	8	49	2A
3Y2	9	48	3A
4Y1	10	47	4A
GND	11	46	GND
4Y2	12	45	12A
5Y1	13	44	12Y1
5Y2	14	43	12Y2
6Y1	15	42	5A
6Y2	16	41	6A
7Y1	17	40	7A
GND	18	39	GND
7Y2	19	38	APAR
8Y1	20	37	8A
8Y2	21	36	YERR
$V_{CC}$	22	35	$V_{CC}$
9Y1	23	34	9A
9Y2	24	33	MODE
GND	25	32	GND
10Y1	26	31	10A
10Y2	27	30	PARI/O
$\overline{PAROE}$	28	29	$\overline{CLKEN}$

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**description (continued)**

$\overline{OE}$  does not affect the internal operation of the device. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16903 is characterized for operation from 0°C to 70°C.

**Function Tables**

FUNCTION

INPUTS					OUTPUTS	
$\overline{OE}$	MODE	$\overline{CLKEN}$	CLK	A	$1Y_n^\dagger - 8Y_n^\dagger$	$9Y_n^\dagger - 12Y_n^\dagger$
L	L	L	↑	H	H	H
L	L	L	↑	L	L	L
L	L	H	↑	H	$Y_0$	H
L	L	H	↑	L	$Y_0$	L
L	H	X	X	H	H	H
L	H	X	X	L	L	L
H	X	X	X	X	Z	Z

$^\dagger n = 1, 2$

PARITY FUNCTION

INPUTS						OUTPUT $\overline{YERR}$
$\overline{OE}$	$\overline{PAROE}^\ddagger$	$11A/\overline{YERR}^\S$	PARI/O	$\Sigma$ OF INPUTS $1A - 10A = H$	APAR	
L	H	L	L	0, 2, 4, 6, 8, 10	L	H
L	H	L	L	1, 3, 5, 7, 9	L	L
L	H	L	L	0, 2, 4, 6, 8, 10	H	L
L	H	L	L	1, 3, 5, 7, 9	H	H
L	H	L	H	0, 2, 4, 6, 8, 10	L	L
L	H	L	H	1, 3, 5, 7, 9	L	H
L	H	L	H	0, 2, 4, 6, 8, 10	H	H
L	H	L	H	1, 3, 5, 7, 9	H	L
H	X	X	X	X	X	H
L	X	H	X	X	X	H

$^\ddagger$  When used as a single device,  $\overline{PAROE}$  must be tied high.

$^\S$  Valid after appropriate number of clock pulses have set internal register

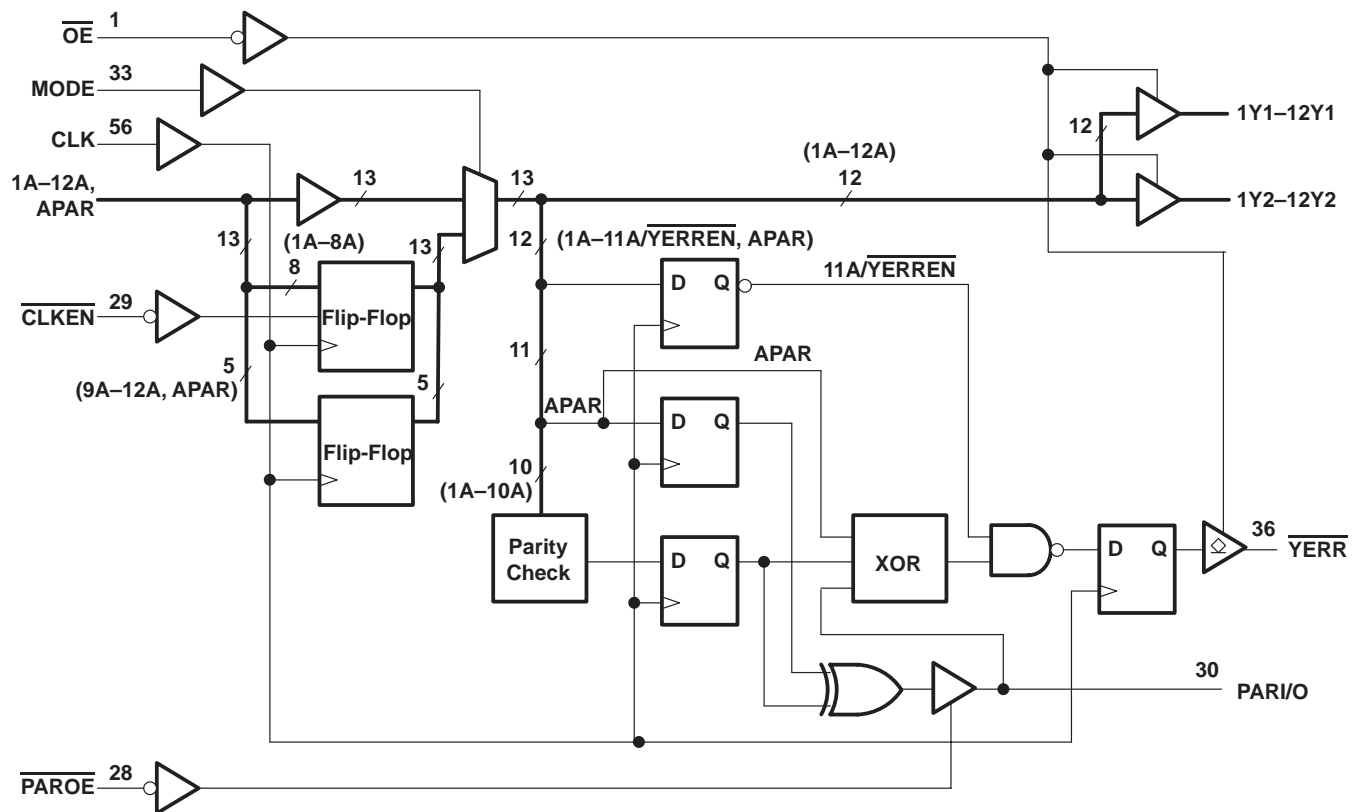
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**Function Tables (Continued)**

PARI/O FUNCTION†			
PAROE	INPUTS		OUTPUT PARI/O
	Σ OF INPUTS 1A – 10A = H	APAR	
L	0, 2, 4, 6, 8, 10	L	L
L	1, 3, 5, 7, 9	L	H
L	0, 2, 4, 6, 8, 10	H	H
L	1, 3, 5, 7, 9	H	L
H	X	X	Z

† This table applies to the first device of a cascaded pair of ALVCH16903 devices.

**logic diagram (positive logic)**



# SN74ALVCH16903

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	–0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 4.6 V
Output voltage range, $V_O$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Continuous output current, $I_O$	±50 mA
Continuous current through each $V_{CC}$ or GND	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package	81°C/W
DGV package	86°C/W
DL package	74°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. This value is limited to 4.6 V maximum.  
 3. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 4)

		MIN	MAX	UNIT	
$V_{CC}$	Supply voltage	2.3	3.6	V	
$V_{IH}$	High-level input voltage	$V_{CC} = 2.3$ V to 2.7 V		V	
		$V_{CC} = 2.7$ V to 3.6 V			
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.3$ V to 2.7 V		V	
		$V_{CC} = 2.7$ V to 3.6 V			
$V_I$	Input voltage	0	$V_{CC}$	V	
$V_O$	Output voltage	0	$V_{CC}$	V	
$I_{OH}$	High-level output current	$V_{CC} = 2.3$ V	Y port	–12	mA
		$V_{CC} = 2.7$ V	Y port	–12	
		$V_{CC} = 3$ V	PARI/O	–12	
			Y port	–24	
$I_{OL}$	Low-level output current	$V_{CC} = 2.3$ V	Y port	12	mA
		$V_{CC} = 2.7$ V	Y port	12	
		$V_{CC} = 3$ V	PARI/O	12	
			Y port	24	
			$\overline{YERR}$ output	24	
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V	
$T_A$	Operating free-air temperature	0	70	°C	

NOTE 4: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP†	MAX	UNIT	
V <sub>OH</sub>	Y port	I <sub>OH</sub> = -100 μA	2.3 V to 3.6 V	V <sub>CC</sub> -0.2			V	
		I <sub>OH</sub> = -6 mA, V <sub>IH</sub> = 1.7 V	2.3 V	2				
		I <sub>OH</sub> = -12 mA	V <sub>IH</sub> = 1.7 V	2.3 V	1.7			
			V <sub>IH</sub> = 2 V	2.7 V	2.2			
				3 V	2.4			
	I <sub>OH</sub> = -24 mA, V <sub>IH</sub> = 2 V	3 V	2					
PAR/O	I <sub>OH</sub> = -12 mA, V <sub>IH</sub> = 2 V	3 V	2					
V <sub>OL</sub>	Y port	I <sub>OL</sub> = 100 μA	2.3 V to 3.6 V			0.2	V	
		I <sub>OL</sub> = 6 mA, V <sub>IL</sub> = 0.7 V	2.3 V			0.4		
		I <sub>OL</sub> = 12 mA	V <sub>IL</sub> = 0.7 V	2.3 V				0.7
			V <sub>IL</sub> = 0.8 V	2.7 V				0.4
		I <sub>OL</sub> = 24 mA, V <sub>IL</sub> = 0.8 V	3 V			0.55		
	PAR/O	I <sub>OL</sub> = 12 mA, V <sub>IL</sub> = 0.8 V	3 V			0.55		
YERR output	I <sub>OL</sub> = 24 mA	3 V			0.5			
I <sub>I</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V			±5	μA	
I <sub>I</sub> (hold)		V <sub>I</sub> = 0.7 V	2.3 V	45			μA	
		V <sub>I</sub> = 1.7 V	2.3 V	-45				
		V <sub>I</sub> = 0.8 V	3 V	75				
		V <sub>I</sub> = 2 V	3 V	-75				
		V <sub>I</sub> = 0 to 3.6 V‡	3.6 V			±500		
I <sub>OH</sub>	YERR output	V <sub>O</sub> = V <sub>CC</sub>	0 to 3.6 V			±10	μA	
I <sub>OZ</sub> §		V <sub>O</sub> = V <sub>CC</sub> or GND	3.6 V			±10	μA	
I <sub>CC</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	3.6 V			40	μA	
ΔI <sub>CC</sub>		One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	5.5			pF	
	Data inputs			5.5				
C <sub>o</sub>	YERR output	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V	5			pF	
	Data outputs			6				
C <sub>io</sub>	PAR/O	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V	7			pF	

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figures 1 and 4)

			V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency		125		125		125		MHz
t <sub>w</sub>	Pulse duration, CLK↑		3		3		3		ns
t <sub>su</sub>	Setup time	1A–12A before CLK↑	Register mode	1.7	1.9	1.45			ns
		1A–10A before CLK↑	Buffer mode	5.9	5.2	4.4			
		APAR before CLK↑	Register mode	1.2	1.5	1.3			
			Buffer mode	4.6	3.6	3.1			
		PARI/O before CLK↑	Both modes	2.4	2	1.7			
		11A/ $\overline{\text{YERREN}}$ before CLK↑	Buffer mode	2	1.9	1.6			
$\overline{\text{CLKEN}}$ before CLK↑	Register mode	2.5	2.6	2.2					
t <sub>h</sub>	Hold time	1A–12A after CLK↑	Register mode	0.4	0.25	0.55			ns
		1A–10A after CLK↑	Buffer mode	0.25	0.25	0.25			
		APAR after CLK↑	Register mode	0.7	0.4	0.7			
			Buffer mode	0.25	0.25	0.25			
		PARI/O after CLK↑	Register mode	0.25	0.25	0.4			
			Buffer mode	0.25	0.25	0.5			
		11A/ $\overline{\text{YERREN}}$ after CLK↑	Buffer mode	0.25	0.25	0.4			
$\overline{\text{CLKEN}}$ after CLK↑	Register mode	0.25	0.5	0.4					

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 4)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>				125		125		125		MHz
t <sub>pd</sub>	Buffer mode	A	Y	1	4.4	4.2	1.1	3.8	ns	
	Both modes	CLK	$\overline{\text{YERR}}$	1	5.7	4.9	1.4	4.4		
PARI/O			1.2	8.6	7.9	1.7	6.6			
t <sub>pd</sub> <sup>†</sup>	Both modes	CLK	PARI/O	1	6.8	5.2	1.3	4.5	ns	
t <sub>pd</sub>	Both modes	MODE	Y	1	5.9	5.8	1.3	4.9	ns	
t <sub>PLH</sub>	Register mode	CLK	Y	1	6.1	5.5	1.2	4.8	ns	
t <sub>PHL</sub>				1	5.9	4.9	1.2	4.6		
t <sub>en</sub>	Both modes	$\overline{\text{OE}}$	Y	1.1	6.5	6.4	1.4	5.4	ns	
		$\overline{\text{PAROE}}$	PARI/O	1	5.6	6	1	4.8		
t <sub>dis</sub>	Both modes	$\overline{\text{OE}}$	Y	1	6.4	5.2	1.7	5	ns	
		$\overline{\text{PAROE}}$	PARI/O	1	3.2	3.8	1.2	3.8		
t <sub>PLH</sub>	Both modes	$\overline{\text{OE}}$	$\overline{\text{YERR}}$	1	3.6	4.2	1.9	4	ns	
t <sub>PHL</sub>				1.2	5.1	4.9	1.5	4.2		

<sup>†</sup> See Figures 2 and 5 for the load specification.

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**simultaneous switching characteristics (see Figures 3 and 6)†**

PARAMETER		FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Register mode	CLK	Y	1.8	6.5	6.1		1.8	5	ns
t <sub>PHL</sub>				1.4	5.9	5.1		1.7	4.5	

† All outputs switching

**operating characteristics for buffer mode, T<sub>A</sub> = 25°C**

PARAMETER			TEST CONDITIONS	V <sub>CC</sub> = 2.5 V ± 0.2 V	V <sub>CC</sub> = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	
C <sub>pd</sub>	Power dissipation capacitance	Outputs enabled	C <sub>L</sub> = 0, f = 10 MHz	57.5	65	pF
		Outputs disabled		15	17.5	

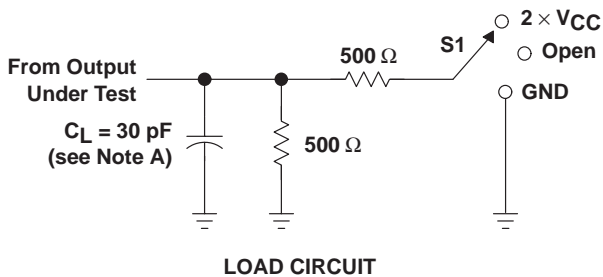
**operating characteristics for register mode, T<sub>A</sub> = 25°C**

PARAMETER			TEST CONDITIONS	V <sub>CC</sub> = 2.5 V ± 0.2 V	V <sub>CC</sub> = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	
C <sub>pd</sub>	Power dissipation capacitance	Outputs enabled	C <sub>L</sub> = 0, f = 10 MHz	57	87.5	pF
		Outputs disabled		16.5	34	

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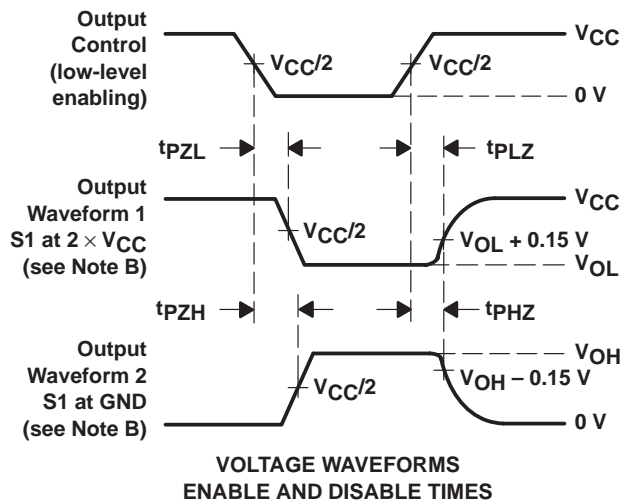
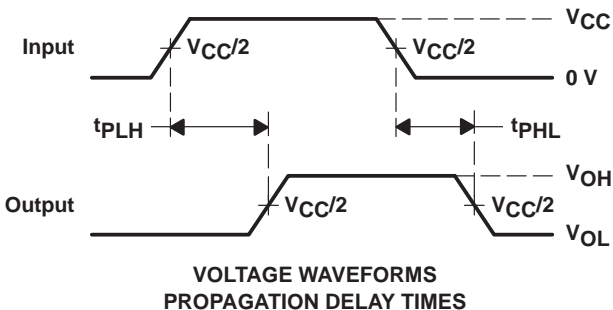
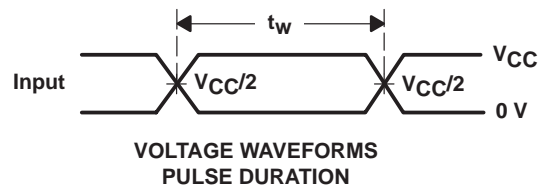
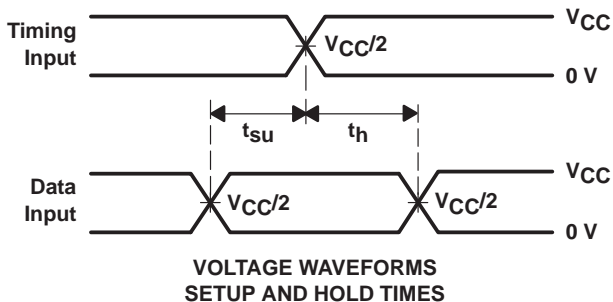
**PARAMETER MEASUREMENT INFORMATION**

$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	$2 \times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND

$\overline{YERR}$	S1
$t_{PHL}$ (see Note H)	$2 \times V_{CC}$
$t_{PLH}$ (see Note I)	$2 \times V_{CC}$



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H.  $t_{PHL}$  is measured at  $V_{CC}/2$ .
  - I.  $t_{PLH}$  is measured at  $V_{OL} + 0.15\text{ V}$ .

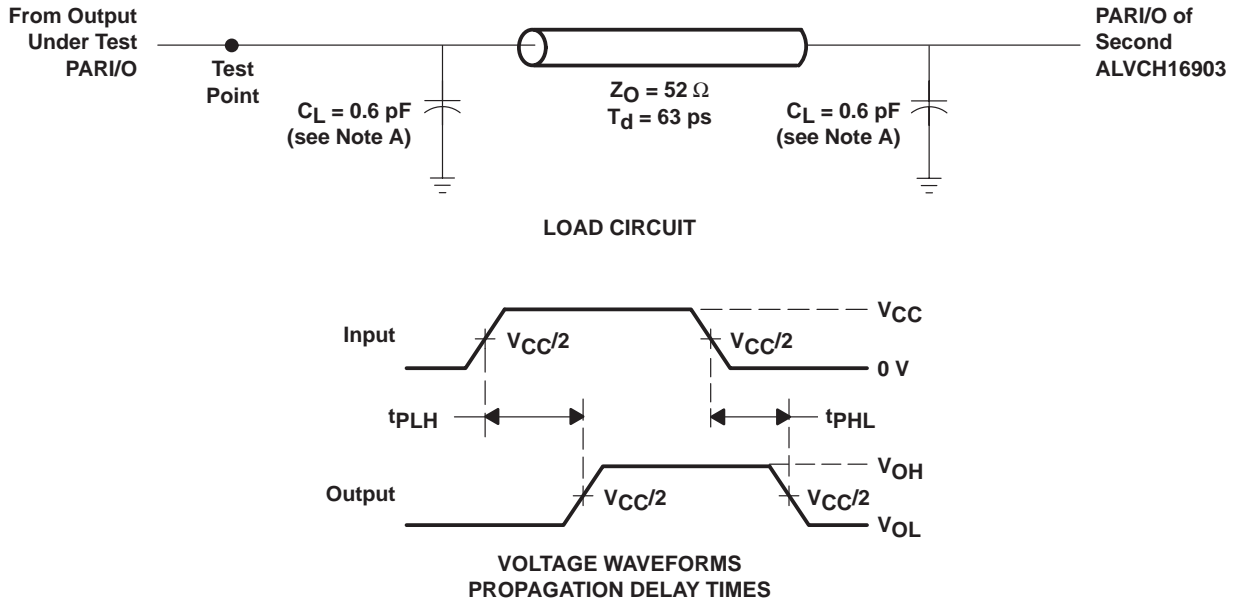
**Figure 1. Load Circuit and Voltage Waveforms**



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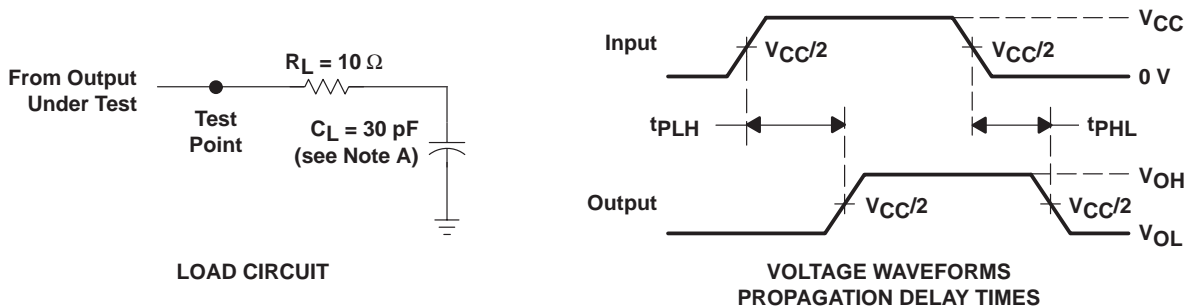
**PARAMETER MEASUREMENT INFORMATION**

$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
 C.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 2. Load Circuit and Voltage Waveforms**

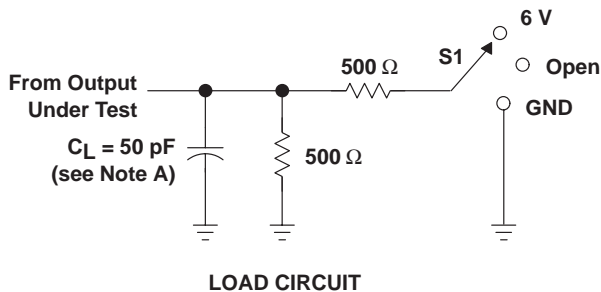


- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .

**Figure 3. Load Circuit and Voltage Waveforms**

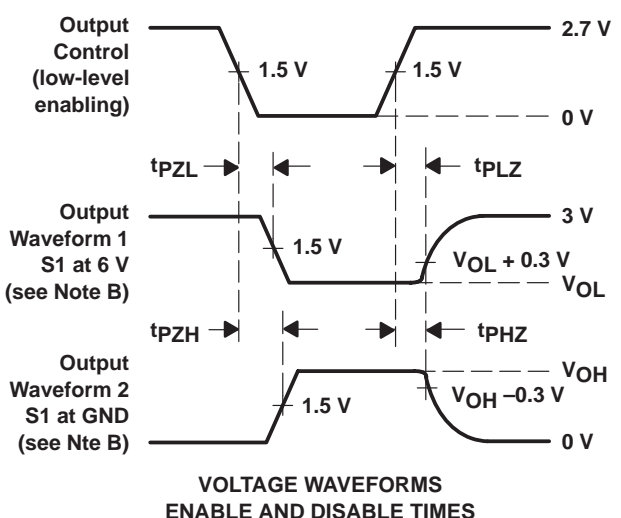
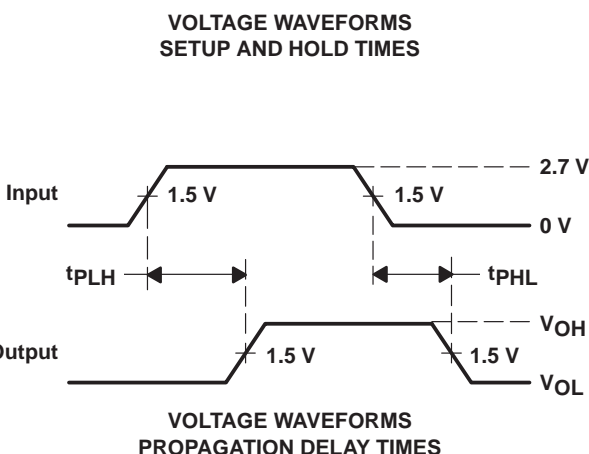
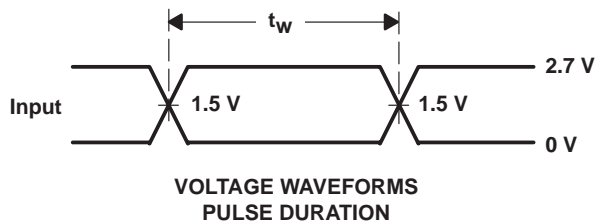
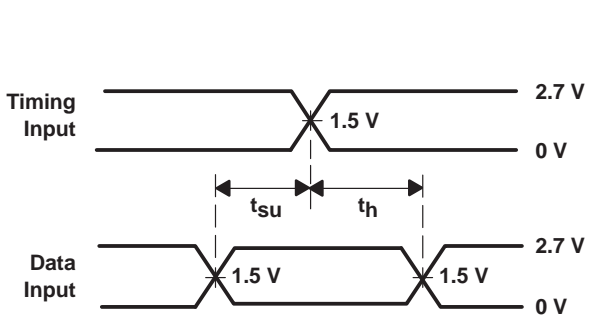
**SN74ALVCH16903**  
**3.3-V 12-BIT UNIVERSAL BUS DRIVER**  
**WITH PARITY CHECKER AND DUAL 3-STATE OUTPUTS**  
 SCES095C – MARCH 1997 – REVISED MAY 1998

**PARAMETER MEASUREMENT INFORMATION**  
 $V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND

$\overline{\text{YERR}}$	S1
$t_{PHL}$ (see Note H)	6 V
$t_{PLH}$ (see Note I)	6 V

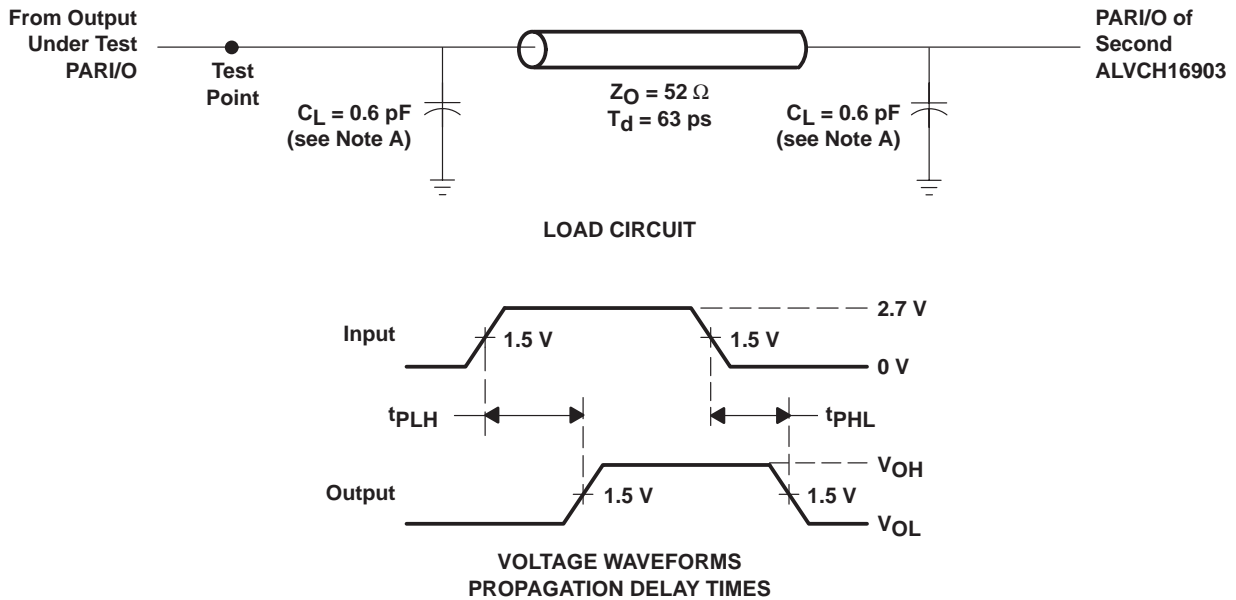


- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .  
 D. The outputs are measured one at a time with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .  
 H.  $t_{PHL}$  is measured at 1.5 V.  
 I.  $t_{PLH}$  is measured at  $V_{OL} + 0.3\text{ V}$ .

**Figure 4. Load Circuit and Voltage Waveforms**

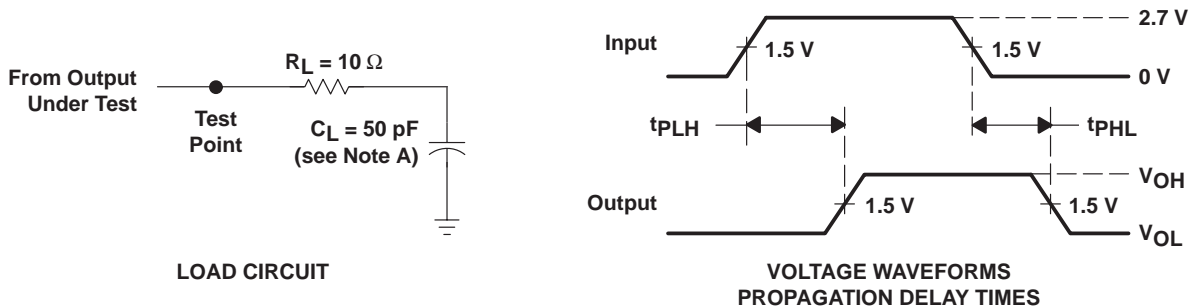
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- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_0 = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .  
 C.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 5. Load Circuit and Voltage Waveforms**



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_0 = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .

**Figure 6. Load Circuit and Voltage Waveforms**

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